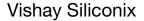
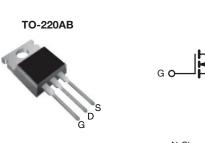
SiHP12N60E





E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.38		
Q _g max. (nC)	58			
Q _{gs} (nC)	6			
Q _{gd} (nC)	13			
Configuration	Single			



S

N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP12N60E-E3			
Lead (Pb)-free and Halogen-free	SiHP12N60E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600	V	
Gate-Source Voltage			V _{GS}	± 30	V	
Continuous Drain Current (T 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	1	12		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	VGS AL TU V	T _C = 100 °C	I _D	7.8	А	
Pulsed Drain Current ^a			I _{DM}	27		
Linear Derating Factor				1.2	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	117	mJ	
Maximum Power Dissipation			PD	147	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope T _J = 125 °C		dV/dt	70			
Reverse Diode dV/dt ^d			5	V/ns		
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 11.6 mH, $R_g = 25 \Omega$, $I_{AS} = 4.5$ A.

c. 1.6 mm from case. d. $I_{SD} \le I_D$, dl/dt = 100 A/µs, starting $T_J = 25$ °C.

1



HALOGEN

FREE

RoHS COMPLIANT



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PARAMETER	SYMBOL	TYP.	MAX	MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 62 - 0.85						
Maximum Junction-to-Case (Drain)	R _{thJC}			5	°C/W			
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	ise noted)						
PARAMETER	SYMBOL	1	CONDITIONS	MIN.	TYP.	MAX.	UNI	
Static							<u> </u>	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μΑ	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I _D = 1 mA	-	0.71	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}	-	= V _{GS} , I _D = 250 μA	2	-	4	V	
	GO(iii)		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 V$		-	± 1	μA	
	<u> </u>		= 600 V, V _{GS} = 0 V	-	-	1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}		⁷ , V _{GS} = 0 V, T _J = 125 °C	-	-	10		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A	-	0.32	0.38	Ω	
Forward Transconductance	g _{fs}	V _{DS}	= 40 V, I _D = 8 A	-	3.8	-	S	
Dynamic	•	-		•	•	•		
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	937	-		
Output Capacitance	C _{oss}			-	53	-		
Reverse Transfer Capacitance	C _{rss}			-	5	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	41	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	136	-]	
Total Gate Charge	Qg	V _{GS} = 10 V I _D = 6 A, V _{DS} = 480 V		-	29	58	nC	
Gate-Source Charge	Q _{gs}			-	6	-		
Gate-Drain Charge	Q _{gd}			-	13	-	1	
Turn-On Delay Time	t _{d(on)}			-	14	28		
Rise Time	t _r	Vpp	= 480 V, I _D = 6 A,	-	19	38	ns	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	$= 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$	-	35	70		
Fall Time	t _f			-	19	38		
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.1	-	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12		
Pulsed Diode Forward Current	I _{SM}			-	-	48	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 6 A, V _{GS} = 0 V	-	-	1.2	V	
Reverse Recovery Time	t _{rr}			-	350	-	ns	
Reverse Recovery Charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 6 A, dI/dt = 100 A/μs, V _R = 25 V		-	4	-	μC	
Reverse Recovery Current	I _{RRM}			-	19	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



SiHP12N60E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

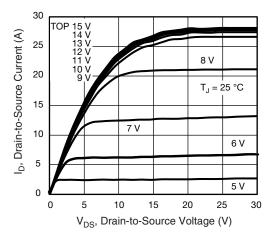


Fig. 1 - Typical Output Characteristics

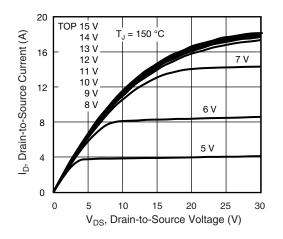


Fig. 2 - Typical Output Characteristics

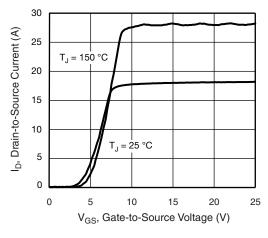


Fig. 3 - Typical Transfer Characteristics

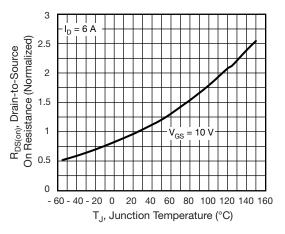


Fig. 4 - Normalized On-Resistance vs. Temperature

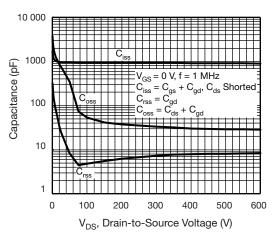


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

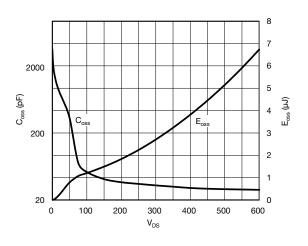


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

S15-0277-Rev. D, 23-Feb-15

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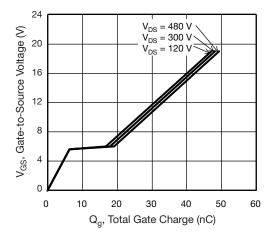


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

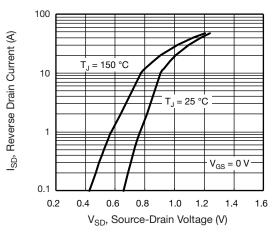


Fig. 8 - Typical Source-Drain Diode Forward Voltage

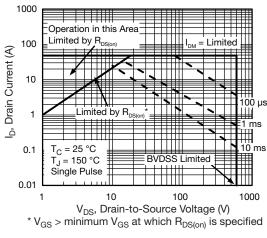


Fig. 9 - Maximum Safe Operating Area

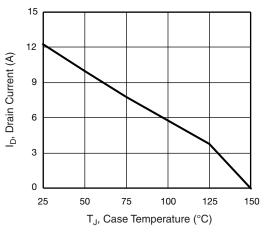


Fig. 10 - Maximum Drain Current vs. Case Temperature

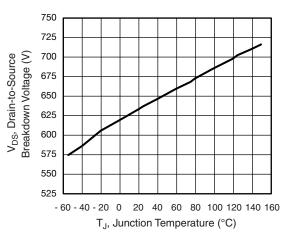
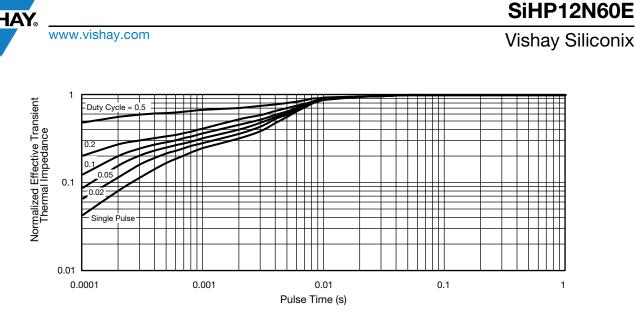


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

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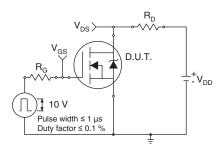


Fig. 13 - Switching Time Test Circuit

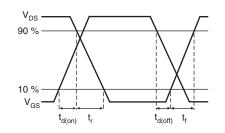
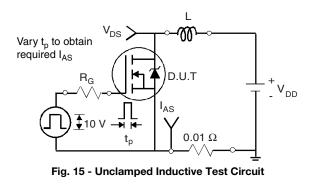


Fig. 14 - Switching Time Waveforms



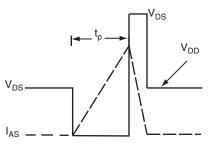


Fig. 16 - Unclamped Inductive Waveforms

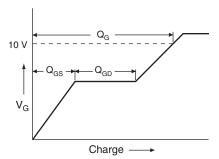


Fig. 17 - Basic Gate Charge Waveform

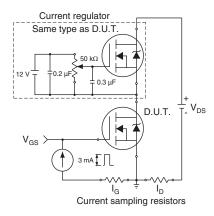


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

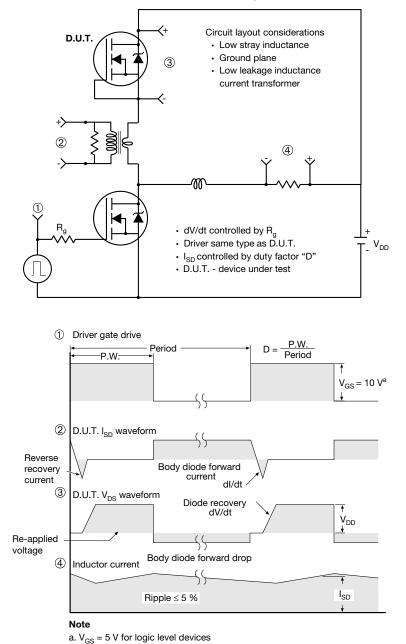


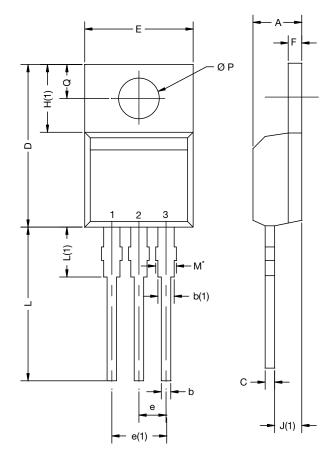
Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

Document Number: 66542

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